

MOSFET

OptiMOS[™] Power-Transistor, -100 V

Features

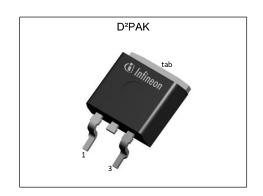
- P-channel
- 100% avalanche tested
- Normal level
- Enhancement mode
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

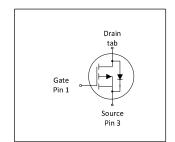
Product validation

Fully qualified according to JEDEC for Industrial Applications

Key Performance Parameters Table 1

Parameter	Value	Unit	
V _{DS}	-100	V	
R _{DS(on),max}	33	mΩ	
I _D	-62	А	
$Q_{ m oss}$	-66	nC	
Q _G	-189	nC	











Type / Ordering Code	Package	Marking	Related Links
IPB330P10NM	PG-TO263-3	330P10NM	-

OptiMOSTM Power-Transistor, -100 V IPB330P10NM



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OptiMOS[™] Power-Transistor, -100 V IPB330P10NM



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

D	C	Values					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	ID	- - -	-	-62 -44 -6.9	A	V _{GS} =-10 V, T _C =25 °C V _{GS} =-10 V, T _C =100 °C V _{GS} =-10 V, T _A =25 °C, R _{thJA} =40 °C/W ²)	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	-248	Α	<i>T</i> _A =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	1960	mJ	I_D =-53 A, R_{GS} =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P_{tot}	-	-	300 3.8	W	T _C =25 °C T _A =25 °C, R _{thJA} =40 °C/W ²⁾	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56	

2 Thermal characteristics

Table 3 **Thermal characteristics**

Davamatav	Symbol	Values			Unit	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	0.5	°C/W	-	
Thermal resistance, junction - ambient, 6 cm² cooling area	R _{thJA}	-	-	40	°C/W	-	
Thermal resistance, junction - ambient, minimal footprint ²⁾	R_{thJA}	-	_	62	°C/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

OptiMOS[™] Power-Transistor, -100 V IPB330P10NM



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

D	0		Values				
Parameter	Symbol	Min.	Тур. Мах.		Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	-100	-	-	V	V _{GS} =0 V, I _D =-1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	-2.1	-3	-4	V	V _{DS} =V _{GS} , I _D =-5550 μA	
Zero gate voltage drain current	I _{DSS}	-	-0.1 -10	-1 -100	μA	V _{DS} =-100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =-100 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	_	-10	-100	nA	V _{GS} =-20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	_	26.8	33	mΩ	V _{GS} =-10 V, I _D =-53 A	
Gate resistance	R _G	-	5.4	-	Ω	-	
Transconductance	g_{fs}	-	75	-	S	V _{DS} ≥2 I _D R _{DS(on)max} , I _D =-53 A	

Table 5 **Dynamic characteristics**

Davamatav	Cymab al	Values			11	Nata / Tast Can dition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance ¹⁾	Ciss	-	8200	11000	pF	V _{GS} =0 V, V _{DS} =-50 V, f=1 MHz	
Output capacitance ¹⁾	Coss	-	580	750	pF	V _{GS} =0 V, V _{DS} =-50 V, f=1 MHz	
Reverse transfer capacitance ¹⁾	C _{rss}	-	110	190	pF	V _{GS} =0 V, V _{DS} =-50 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	13.08	-	ns	$V_{\rm DD}$ =-50 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-53 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	_	51.1	-	ns	$V_{\rm DD}$ =-50 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-53 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{ m d(off)}$	-	177.95	-	ns	$V_{\rm DD}$ =-50 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-53 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t _f	_	81.95	-	ns	$V_{\rm DD}$ =-50 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-53 A, $R_{\rm G,ext}$ =1.6 Ω	

Gate charge characteristics²⁾ Table 6

Devemente	Comple al		Values			Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q_{gs}	-	-39	-	nC	V_{DD} =-50 V, I_{D} =-53 A, V_{GS} =0 to -10 V	
Gate charge at threshold	$Q_{g(th)}$	-	-25	-	nC	V_{DD} =-50 V, I_{D} =-53 A, V_{GS} =0 to -10 V	
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	-59	-89	nC	V_{DD} =-50 V, I_{D} =-53 A, V_{GS} =0 to -10 V	
Switching charge	Q _{sw}	-	-74	-	nC	V_{DD} =-50 V, I_{D} =-53 A, V_{GS} =0 to -10 V	
Gate charge total ¹⁾	Qg	-	-189	-236	nC	V_{DD} =-50 V, I_{D} =-53 A, V_{GS} =0 to -10 V	
Gate plateau voltage	V _{plateau}	-	-4.8	-	V	V_{DD} =-50 V, I_{D} =-53 A, V_{GS} =0 to -10 V	
Output charge ¹⁾	Qoss	-	-66	-88	nC	V _{DS} =-50 V, V _{GS} =0 V	

Defined by design. Not subject to production test.
See "Gate charge waveforms" for parameter definition

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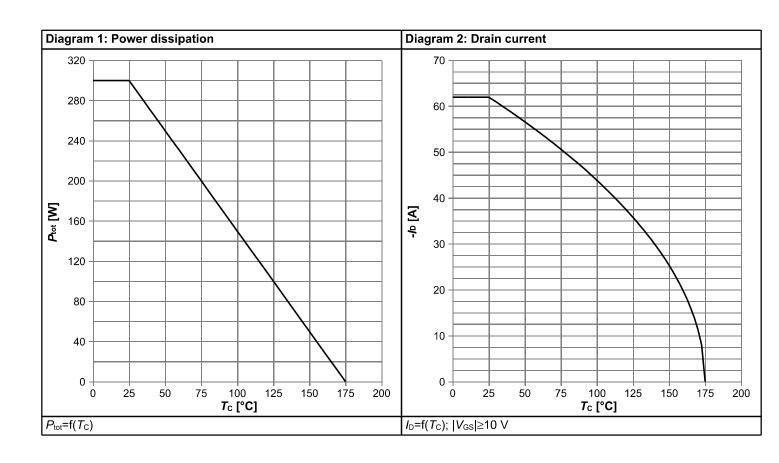


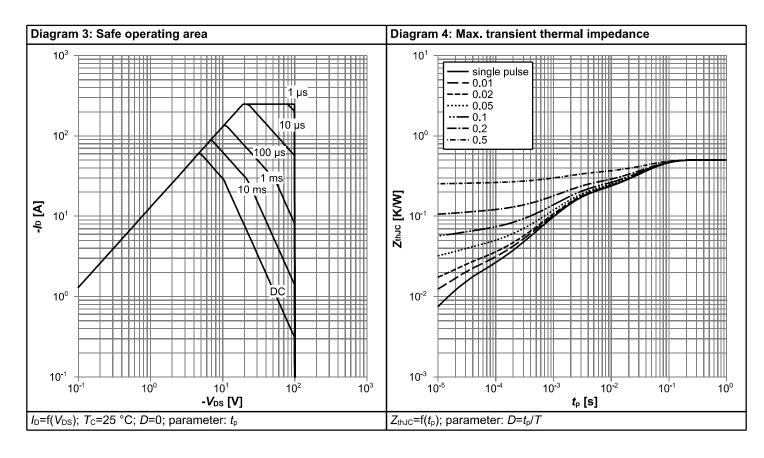
Table 7 Reverse diode

Downwoodow.	Combal		Values			Nata / Tant Canadition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	-62	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	-248	Α	T _C =25 °C	
Diode forward voltage	V _{SD}	-	-0.86	-1.2	V	V_{GS} =0 V, I_F =-53 A, T_j =25 °C	
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	110	220	ns	V _R =-50 V, I _F =-53 A, d <i>i</i> _F /d <i>t</i> =-100 A/μs	
Reverse recovery charge ¹⁾	Q _{rr}	-	588.56	1177.1	nC	V _R =-50 V, I _F =-53 A, di _F /dt=-100 A/μs	

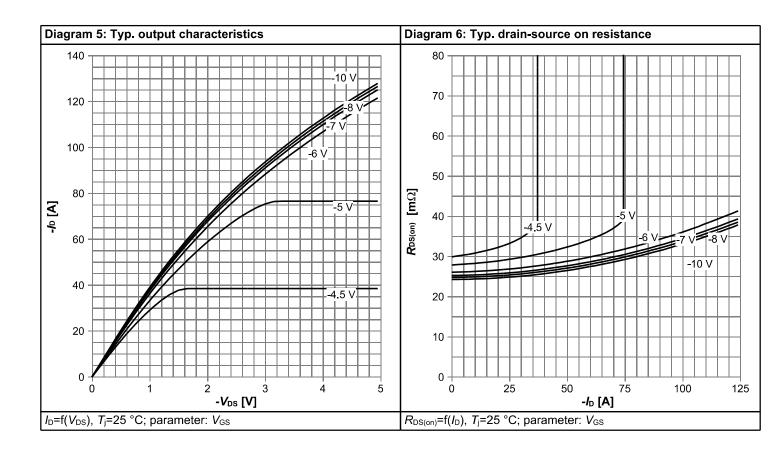


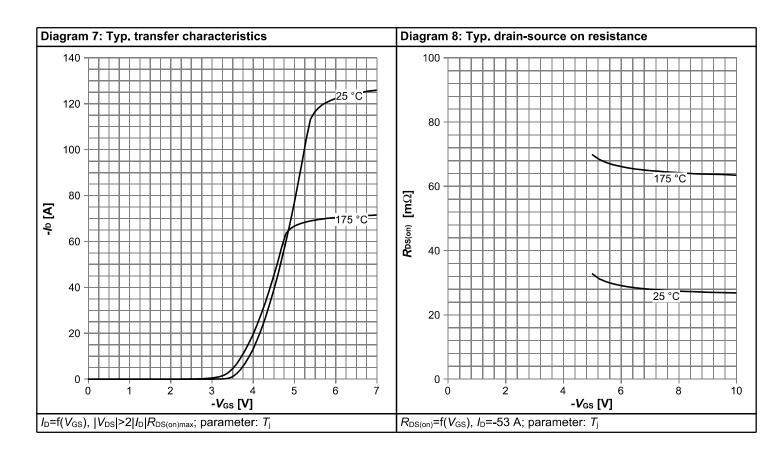
4 Electrical characteristics diagrams



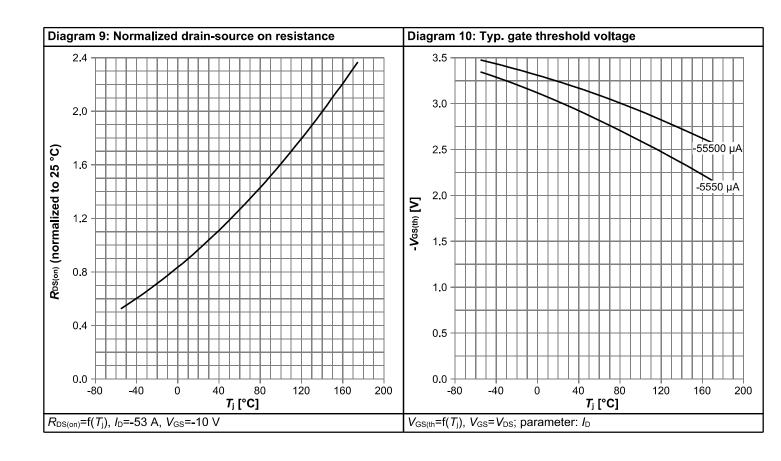


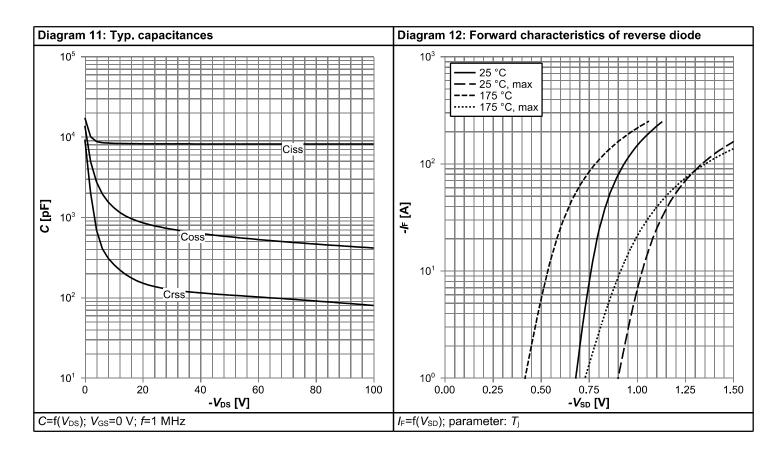




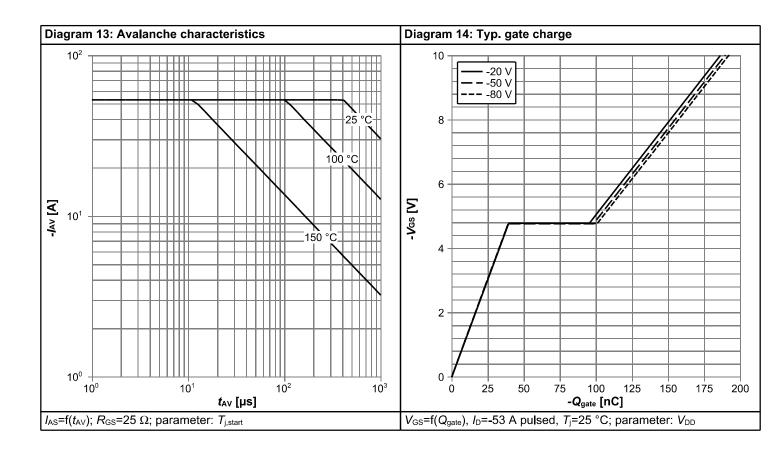


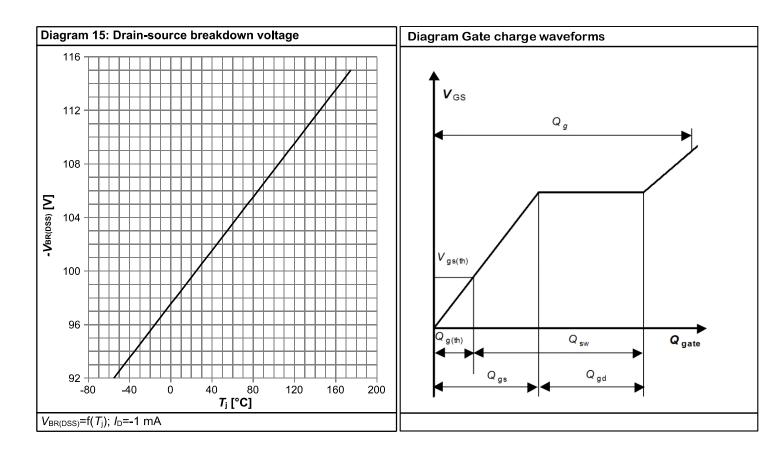






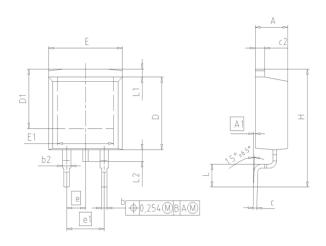


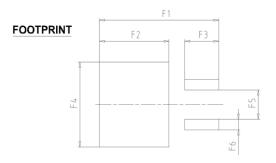






5 Package Outlines





DIM	MILLIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	4.30	4.57	0.169	0.180	
A1	0.00	0.25	0.000	0.010	
b	0.65	0.85	0.026	0.033	
b2	0.95	1.15	0.037	0.045	
С	0.33	0.65	0.013	0.026	
c2	1.17	1.40	0.046	0.055	
D	8.51	9.45	0.335	0.372	
D1	7.10	7.90	0.280	0.311	
E	9.80	10.31	0.386	0.406	
E1	6.50	8.60	0.256	0.339	
е	2.5	54	0.100		
e1	5.0	08	0.200		
N		2	2		
Н	14.61	15.88	0.575	0.625	
L	2.29	3.00	0.090	0.118	
L1	0.70	1.60	0.028	0.063	
L2	1.00	1.78	0.039	0.070	
F1	16.05	16.25	0.632	0.640	
F2	9.30	9.50	0.366	0.374	
F3	4.50	4.70	0.177	0.185	
F4	10.70	10.90	0.421	0.429	
F5	3.65	3.85	0.144	0.152	
F6	1.25	1.45	0.049	0.057	

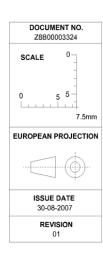


Figure 1 Outline PG-TO263-3, dimensions in mm/inches

OptiMOS[™] Power-Transistor, -100 V IPB330P10NM



Revision History

IPB330P10NM

Revision: 2021-05-24, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2021-05-24	Release of final version

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